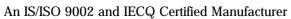


# Continental Device India Limited







### **SOT-23 Formed SMD Package**

BC856 BC857 BC858

# SILICON PLANAR EPITAXIAL TRANSISTORS

P-N-P transistors

Marking $BC856 = 3D$ $BC856A = 3A$ $BC856B = 3B$	PACKAGE OUTI ALL DIMENSI	
BC857 = 3H BC857A = 3E BC857B = 3F BC857C = 3G BC858 = 3M BC858A = 3J BC858B = 3K BC858C = 3L	2.8 0.48 0.38 3	0.14 0.09 0.70 0.50 1.4 1.2
Pin configuration  1 = BASE  2 = EMITTER  3 = COLLECTOR	1.02 0.60 0.40 2.00 1.80	R0.1 (.004) R0.05 (.002) 0.02 1.15 0.90

## ABSOLUTE MAXIMUM RATINGS

			BC856	BC857	BC85	5 <b>8</b>
Collector-emitter voltage (+ $V_{BE} = 1 \ V$ )	$-V_{CEX}$	max.	80	50	30	V
Collector-emitter voltage (open base)	-V <sub>CE0</sub>	max.	65	45	30	V
Collector current (peak value)	$-I_{CM}$	max.		200		mA
Total power dissipation						
$up to T_{amb} = 60  ^{\circ}C$	$P_{tot}$	max.		<i>250</i>		mW
Junction temperature	$T_{j}$	max.		<i>150</i>		$^{\circ}$ $C$
Small-signal current gain	v					
$-I_C = 2 \text{ mA}$ ; $-V_{CE} = 5 \text{ V}$ ; $f = 1 \text{ kHz}$	$h_{fe}$		7	'5 to 90	0	
Transition frequency at $f = 100 \text{ MHz}$						
$-I_C = 10 \text{ mA; } -V_{CE} = 5 \text{ V}$	$f_T$	>		100		МНz
Noise figure at $R_S = 2 \text{ kW}$						
$-I_C = 200 \text{ mA}; -V_{CE} = 5 \text{ V}$						
f = 1  kHz; B = 200  Hz	$\boldsymbol{F}$	<		10		dB

# **RATINGS** (at $T_A = 25$ °C unless otherwise specified) Limiting values

Zamang values		i	BC856	BC857	BC85	8
Collector-base voltage (open emitter)	$-V_{CBO}$	max.	80	50	30	$\overline{V}$
Collector-emitter voltage $(+V_{BE} = 1 \ V)$	$-V_{CEX}$	max.	<i>80</i>	50	30	V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	65	45	30	V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	5	5	5	V
Collector current (d.c.)	$-I_C$	max.		100	l	mA
Collector current (peak value)	$-I_{CM}$	max.		200		mA
Emitter current (peak value)	$I_{EM}$	max.		200		mA
Base current (peak value)	$-I_{BM}$	max.		200		mA
Total power dissipation						
up to $T_{amb}$ : 60 °C	$P_{tot}$	max.		<i>250</i>		mW
Storage temperature	$T_{stg}$		-3	55 to +1	50	${}^{\!$
Junction temperature	$T_j$	max.		150		${\mathscr C}$
THERMAL CHARACTERISTICS						
$T_j = P_X (R_{th j-t} + R_{th t-s} + R_{th s-a})^+ T_{amb}$ Thermal resistance						
From junction to tab	$R_{thj-t}$	=		60		KW
From tab to soldering points	$R_{th\ t-s}$	=		280		KW
From soldering points to ambient	R <sub>th s-a</sub>	=		90		KW
	ui s-a					
CHARACTERISTICS						
$T_j = 25$ °C unless otherwise specified						
Collector cut-off current						
$I_E = 0$ ; $-V_{CB} = 30V$ ; $T_i = 25^{\circ}C$	$-I_{CBO}$	typ.		1		nΑ
J		<		15		nA
$T_j = 150^{\circ} C$	-I <sub>CBO</sub>	<		4		$\mathfrak{m}A$
Base-emitter voltage						
$-I_C = 2 \text{ mA; } -V_{CE} = 5 \text{ V}$	$-V_{BE}$	typ.		650		mV
IC Z III I, VCE UV	* DE	ijρ.	6	200 to 7.	50	mV
			U		<i>,</i>	
$-I_C = 10 \text{ mA; } -V_{CE} = 5 \text{ V}$	$-V_{BE}$	<		820		mV
Saturation voltages						
$-I_C = 10 \text{ mA}; -I_B = 0.5 \text{ mA}$	-V <sub>CEsat</sub>	typ.		75		mV
, <u>b</u>	CLour	<		300		mV
	Vpr.			700		mV
	-V <sub>BEsat</sub>	typ.		700		III V
$-I_C = 100 \text{ mA}; -I_B = 5 \text{ mA}$	-V <sub>CEsat</sub>	typ.		250		mV
0 0	02541	<		650		mV
	-V <sub>BEsat</sub>	typ.		850		mV
Knee voltage	DESAL	JF.				• •
$-I_C = 10 \text{ mA}$ ; $-I_B = \text{value for which}$						
$-I_C = 11 \text{ mA at } -V_{CE} = 1 \text{ V}$	-V <sub>CEK</sub>	typ.		250		mV
10 - 11 mm i ac v CE - 1 v	CEK			600		mV
		<		000		111 V

### BC856 BC857 BC858

Collector capacitance at f	= 1 MHz				
$I_E = I_e = 0; -V_{CB} = 1$	10 V	$C_c$	typ.	4,5	рF
Transition frequency at f	= 100 MHz				
$-I_C = 10 \text{ mA; } -V_{CE} = 10 \text{ mA; } -$	= 5 V	$f_T$	>	100	MHz
Small-signal current gain	at $f = 1 \text{ kHz}$				
$-I_C = 2 \text{ mA}; -V_{CE} =$	5 V	$h_{fe}$	125 to	o 800	
Noise figure at $R_S = 2 \text{ kV}$	V				
$-I_C = 200 \text{ mA; } -V_{CE}$	= 5 V				
f = 1  kHz; B = 200  F	Ηz	F	typ.	2	dB
			<	10	dB
D.C. current gain					
$-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ N}$	V BC856	$h_{FE}$	220 to	o 475	
	BC858/857	$h_{\!F\!E}$	125 to	o 800	
	BC856A/857A/858A	$h_{\!F\!E}$	125 to	o 250	
	BC856B/857B/858B	$h_{FE}$	220 to	o 475	
	BC857C/858C	$h_{FE}$	420 to	o 800	

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